

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S2	787	mean time between failure	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/03/15 15:09
S3	323	S2 and (semiconductor or (integrated adj circuit) or ASIC)	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/03/15 15:10
S4	38	coffin adj manson	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/03/20 15:04
S5	17	hot cold testing	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/03/15 17:10
S7	691	(reliability test\$3) with (semiconductor or ASIC or IC)	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/03/15 17:12
S9	1228	MTBF	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/03/15 17:15
S10	757	S9 and (semiconductor\$3 or ASIC or package or chip or IC or silicon)	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/03/15 17:15
S11	33	MTBF with (semiconductor\$3 or ASIC or package or chip or IC or silicon)	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/03/15 17:18
S12	0	(thermal adj profil\$3) same (warrenty) same (MTBF)	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/03/15 17:19
S13	0	(thermal adj profil\$3) same (warrenty)	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/03/16 12:57
S14	0	"09982061"	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/03/16 12:57
S15	1	"09/982061"	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/03/16 12:57
S16	2	(US-6188582-\$ or US-6260998-\$). did.	USPAT	OR	OFF	2005/03/20 15:03
S17	692	703/13.ccls.	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/03/20 15:04
S18	546	703/22.ccls.	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/03/20 15:04
S19	864	mean time between failure	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/10/03 13:05

S20	350	S19 and (semiconductor or (integrated adj circuit) or ASIC)	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/10/03 13:05
S21	40	coffin adj manson	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/10/03 13:05
S22	17	hot cold testing	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/10/03 13:05
S23	760	(reliability test\$3) with (semiconductor or ASIC or IC)	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/10/03 13:05
S24	1360	MTBF	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/10/03 13:05
S25	828	S24 and (semiconductor\$3 or ASIC or package or chip or IC or silicon)	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/10/03 13:05
S26	1360	MTBF	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/10/03 13:05
S27	41	MTBF with (semiconductor\$3 or ASIC or package or chip or IC or silicon)	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/10/03 13:05
S28	0	(thermal adj profil\$3) same (warrenty) same (MTBF)	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/10/03 13:05
S29	0	(thermal adj profil\$3) same (warrenty)	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/10/03 13:05
S30	0	"09982061"	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/10/03 13:05
S31	1	"09/982061"	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/10/03 13:05
S32	2	(US-6188582-\$ or US-6260998-\$). did.	USPAT	OR	OFF	2005/10/03 13:05
S33	770	703/13.ccls.	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/10/03 13:05
S34	622	703/22.ccls.	US-PGPUB; USPAT; USOCR	ADJ	OFF	2005/10/03 13:05